



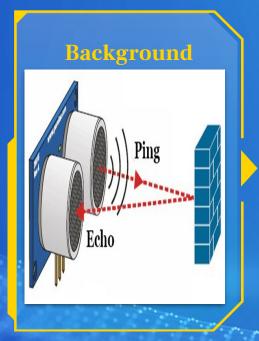
### **Table of Contents**

- 1. Introduction
- 2. Objectives
- 3. Design Concept
- 4. Implementation
- 5. Learning Outcomes 10. Thank You!

- 6. Future Work
- 7. Site Visits
- 8. Acknowledgments
- 9. Q&A



# **Project Introduction**









## **Objectives & Requirements**





## **Design Concept**

### **MCU Main Peripherals**



SWD Debug Serial Port

**LED Module** 

LIN Transceiver

RS232 Transceiver Crystal Circuit DC/DC Module



# **Design & Implementation**

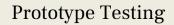
Schematic Design

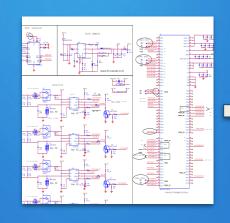


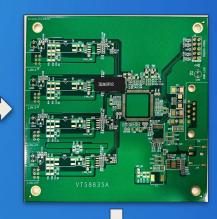
Layout Design



3D Shell Print















### **Learning Outcomes**

#### **Radar Transition Box Development:**

- Engineered a Radar Transition Box with a x4 LIN interface, UART protocols, and RS232 connectivity.
- Achieved seamless data communication, increasing system reliability.

#### **PCB Layout & Design:**

- Created an optimized PCB layout with DC/DC and LDO for voltage conversion.
- Developed a 3D-printed product shell.

#### **Insights into Vehicle Electronics Industry:**

- Gained valuable insights into the vehicle electronics industry, including trends, technologies, and best practices.
- Understood the role of automotive electronics in enhancing vehicle performance and safety.

#### **Project Management:**

- Orchestrated the project lifecycle and led cross-functional teams.
- Boosted system optimization by an estimated 10%.



### **Future Work**



LIN Signal Debugging



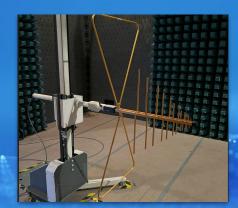
# **Site Visits**















### Acknowledgments

#### Leadership & Guidance:

- Moto: Head of VIA Tech Shenzhen.
- Xindi: Hardware Dept. Leader, supervised progress.
- Jasper: Project Leader, guided design.
- Jepson: Guided SMT factory visit.

#### **Technical Support:**

- Laura: Managed PCB layout.
- Ethan: Technical discussion partner.

#### Internship Experience & Support:

- Jason: Handled recruitment/onboarding.
- MIA: Organized intern activities.

#### Special Thanks:

• To all VIA Technologies staff who provided assistance and support!!!



# **Q&A Session**

2023

